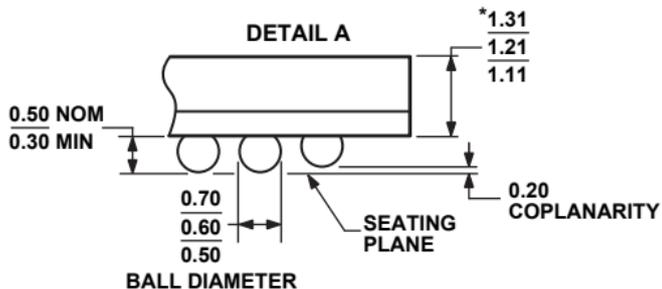
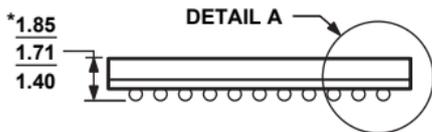
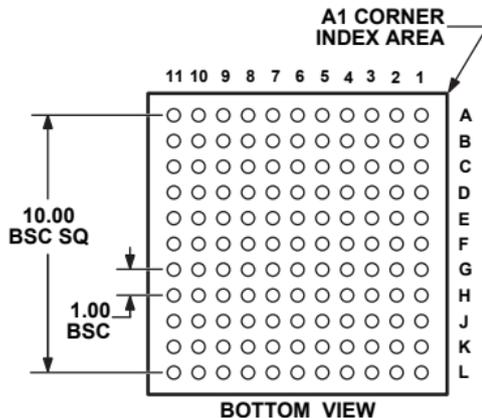
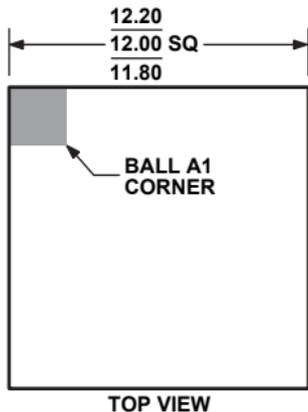


**121-Ball Chip Scale Package Ball Grid Array [CSP_BGA]
(BC-121-1)**

Dimensions shown in millimeters



***COMPLIANT WITH JEDEC STANDARDS MO-192-ABD-1 WITH
EXCEPTION TO PACKAGE HEIGHT AND THICKNESS.**